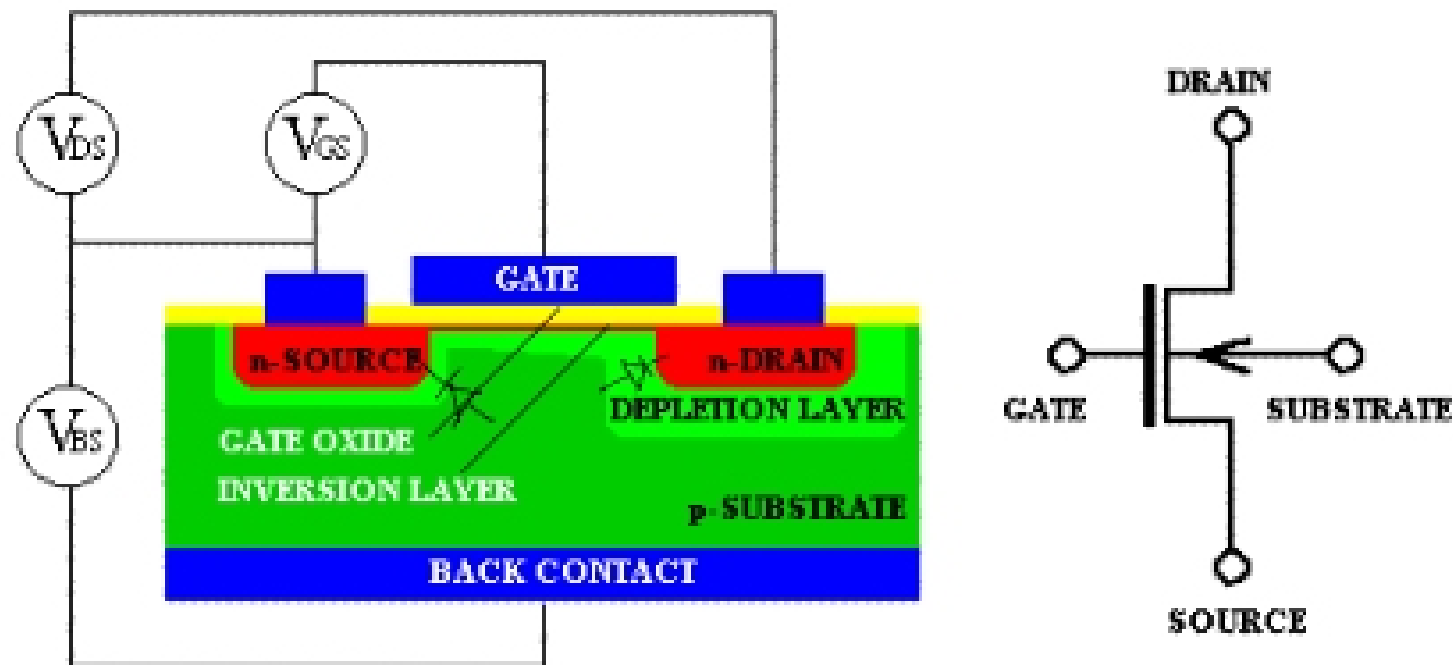


# MOSFET as Voltage Controlled Current Source



- The MOS Capacitor electrically connects the 2 reverse biased p-n junctions
- The gate voltage controls the surface potential at the source end controlling the injection of carriers or not (Field Effect)



- **Linear Model**
  - Predicts correctly the MOSFET behavior for small drain-source voltages
- **Quadratic Model**
  - Includes the voltage variation along the channel between S and D
- Drain Current = (total charge in the inversion layer) / (time of transit carriers between source and drain)

$$I_D = \frac{Q_{inv} w L}{t_r}$$

- If the velocity of the carriers is constant between source and drain, the transit time equals

$$t_{tr} = \frac{L}{v} = \frac{L}{\mu E} = \frac{L^2}{\mu V_{DS}}$$

$$v = \mu E = \mu \frac{V_{DS}}{L}$$

$$I_D = \frac{Q_{inv} w L}{\frac{L^2}{\mu V_{DS}}} = \mu Q_{inv} \left(\frac{w}{L}\right) V_{DS}$$

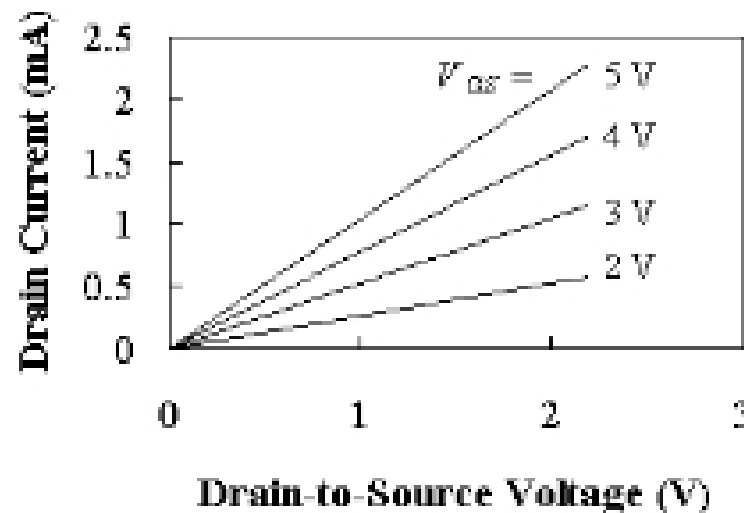


- Assuming that the charge density is constant between the source and drain, we can say

$$Q_{inv} = C_{ox} (V_G - V_t) \leftarrow \text{threshold voltage}$$

$$I_D = \mu \frac{W}{L} C_{ox} (V_{GS} - V_t) V_{DS}$$

- The linear model is valid only when  $V_{DS} \ll V_{GS} - V_T$ . This ensures that the velocity, the electric field and the inversion layer charge density is indeed constant between the source and the drain



VOLTAGE CONTROLLED RESISTOR